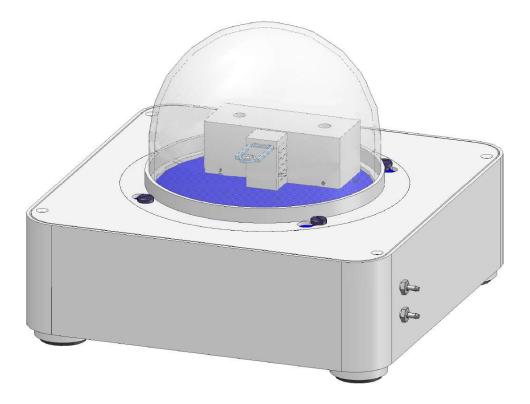


How To Handle high pressure with Chip-DSC



Linseis Messgeräte GmbH Gerlach Stand: 26.08.2021



Index

1.	General information	3
2. Requirements and installation		
	2.1 HP Chip-DSC	3
	2.2 Pressure System	3
	2.3 assemble System	4
	2.4 usage of gases	4
	2.5 test system	4
3. Measurement		5
	4.1 preparation	5
	4.2 measurement	5
	4.3 release measurement system	5



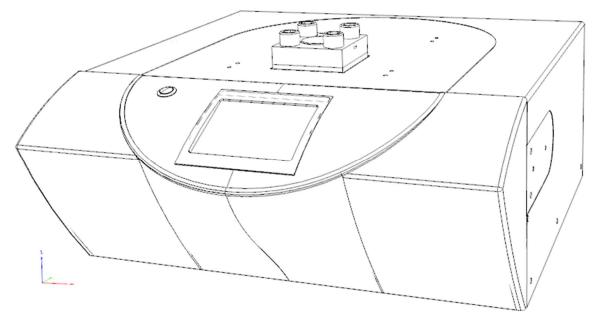
1. General information

This manual is a short description for handling high pressure measurements with the Chip-DSC. The presented options are the most common, that are usually used. However, the high-pressure options are mostly adapted for the special customer requirements. For more Information, read the other available instructions or specific manuals for the Chip DSC.

2. Requirements and installation

2.1 HP Chip-DSC

- A HP Chip-DSC 100 is initially needed (make sure your working bench where its placed fits to the safety requirements to perform measurements under high pressure)
- Approved connections for the specific pressure of the investigation including
- o The tools required for use are supplied with your HP Chip-DSC



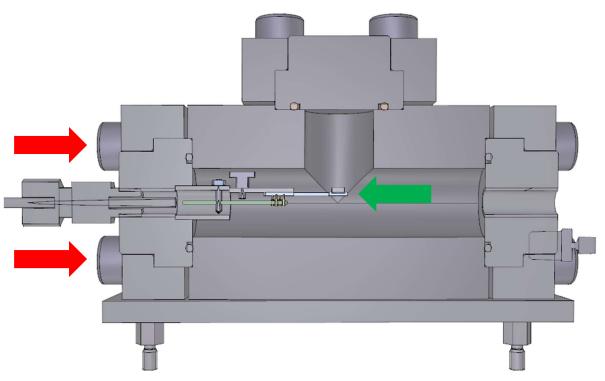
2.2 Pressure System

- For several specifications, different high-pressure systems are available, like manual pressure reducer, internal high pressure MFCs and external gas boxes
- Additionally, to the gas dosing system also a pressure source is needed, that could be a fixed high-pressure system or a high-pressure gas cylinder



2.3 assemble System

- Open the high-pressure measurement cell
- Insert the sensor, place a calibration crucible and close the measurement cell properly



- o Start the Linseis Chip-DSC software and open the calibration menu
- Follow the instructions of *HowTo calibrate with Chip-DSC* especially according to the low temperature option. Instead of cooling the high-pressure is turned on after the "continue when sample 1 is ready" popup window appears
- After calibration release the overpressure carefully

2.4 usage of gases

- The atmosphere you are using affects the measurement
- For various purposes different gases could lead to better results
- o In general gases with higher density are recommended to lower the influence of convection

2.5 test system

- o Before first use its also recommended to test of the system is pressure tight
- o Close all release valves, screws and fittings
- o Let the overpressure carefully into the measurement cell
- Close the pressure source
- o Check if the overpressure in the measurement cell gets lower over time

How To Handle high pressure with Chip-DSC



3. Measurement

4.1 preparation

- Open the measurement cell
- Place the sample on the sensor
- Close the measurement cell and tighten the screws carefully

4.2 measurement

- o Setup the general settings and temperature profile of your measurement in Chip-DSC software
- If available setup the pressure profile in your gas settings. Otherwise put the measurement cell under high pressure
- Click start measurement

4.3 release measurement system

- o After your measurement finished, close high-pressure source.
- Release the overpressure carefully and slowly
- Open the measurement cell
- Remove the sample and replace with a new sample if necessary

